

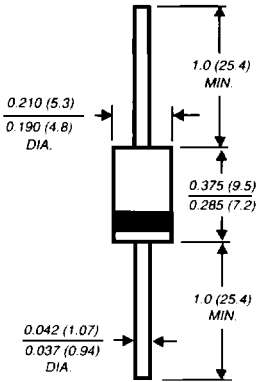
EGP30A THRU EGP30G

GLASS PASSIVATED FAST EFFICIENT RECTIFIER

Forward Voltage - 50 to 400 Volts Reverse Current - 3.0 Amperes

PATENTED *

Case Style GP20



Dimensions in inches and (millimeters)

* Glass-plastic encapsulation technique is covered by Patent No. 3,996,602 and brazed-lead assembly by Patent No. 3,930,306

FEATURES

- ◆ Plastic package has Underwriters Laboratories Flammability Classification 94V-0
- ◆ Glass passivated cavity-free junction
- ◆ Superfast recovery time for high efficiency
- ◆ Low forward voltage, high current capability
- ◆ Low leakage current
- ◆ High surge current capability
- ◆ High temperature metallurgically bonded construction
- ◆ High temperature soldering guaranteed: 300°C/10 seconds, 0.375" (9.5mm) lead length, 5 lbs. (2.3kg) tension

MECHANICAL DATA

Case: Molded plastic over solid glass body

Terminals: Plated axial leads, solderable per MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any

Weight: 0.03 ounce, 0.8 gram

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

	SYMBOLS	EGP 30A	EGP 30B	EGP 30C	EGP 30D	EGP 30F	EGP 30G	UNITS	
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	150	200	300	400	Volts	
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	Volts	
Maximum DC blocking voltage	V _{DC}	50	100	150	200	300	400	Volts	
Maximum average forward rectified current 0.375" (9.5mm) lead length at T _A =55°C	I _(AV)	3.0						Amps	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	125.0						Amps	
Maximum instantaneous forward voltage at 3.0A	V _F	0.95				1.25		Volts	
Maximum DC reverse current at rated DC blocking voltage	I _R	T _A =25°C		5.0		T _A =125°C		100.0	μA
Typical reverse recovery time (NOTE 1)	t _{rr}	50.0						ns	
Typical junction capacitance (NOTE 2)	C _J	95.0				75.0		pF	
Typical thermal resistance (NOTE 3)	R _{θJA} R _{θJL}	20.0 8.0						°C/W	
Operating junction and storage temperature range	T _J , T _{STG}	-65 to +150						°C	

NOTES:

(1) Reverse recovery test conditions: I_F=0.5A, I_R=1.0A, I_{rr}=0.25A

(2) Measured at 1.0 MHz and applied reverse voltage of 4.0 Volts

(3) Thermal resistance from junction to ambient, and from junction to lead 0.375" (9.5mm) lead length, P.C.B. mounted

RATINGS AND CHARACTERISTIC CURVES EGP30A THRU EGP30G

FIG. 1 - MAXIMUM FORWARD CURRENT DERATING CURVE

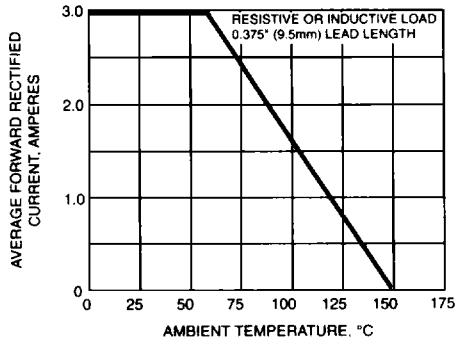


FIG. 2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

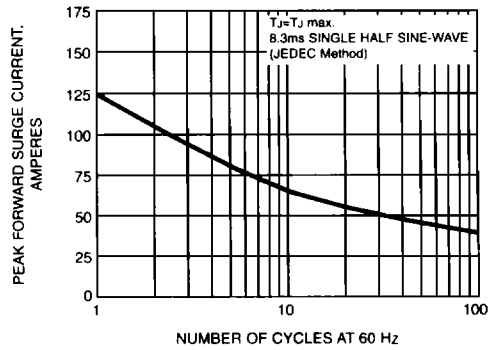


FIG. 3 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

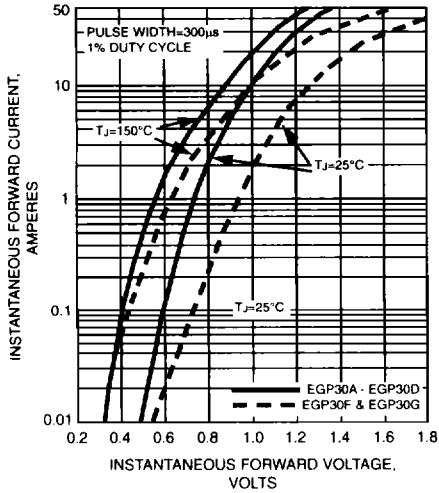


FIG. 4 - TYPICAL REVERSE LEAKAGE CHARACTERISTICS

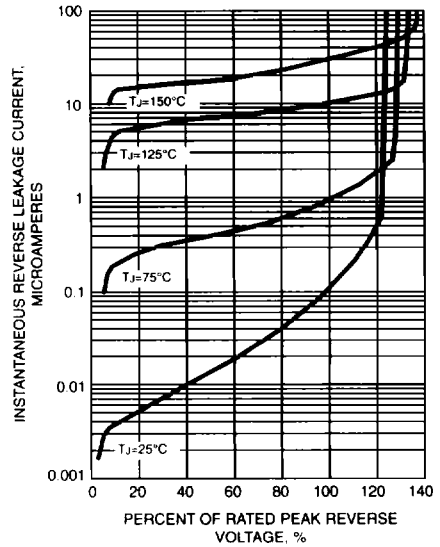


FIG. 5 - TYPICAL JUNCTION CAPACITANCE

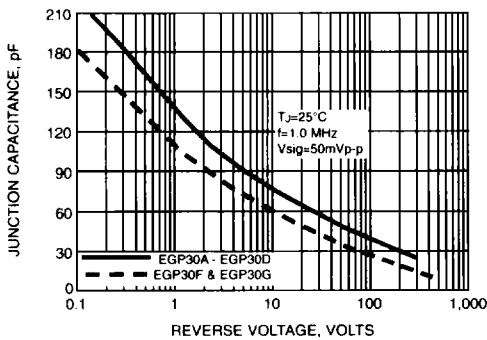


FIG. 6 - TYPICAL TRANSIENT THERMAL IMPEDANCE

